<u>S/N 09/961034</u> <u>PATENT</u>

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

oplicant: Madhav Datta et al.

Examiner: Long Pham

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Group Art Unit: 2814

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Docket No.: 884.522US1

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September 21, 2001

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COPPER-CONTAINING C4 BALL-LIMITING METALLURGY STACK FOR ENHANCED RELIABILITY OF PACKAGED STRUCTURES AND METHOD

OF MAKING SAME

Assignee:

Intel Corporation

AMENDMENT AND RESPONSE UNDER 37 CFR § 1.111

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Applicant has reviewed the Office Action mailed on April 9, 2003. Please amend the above-identified patent application as follows.

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